60V N-Channel Power MOSFET

DESCRIPTION：

- Excellent $R_{DS(ON)}$
- Low Gate Charge
- 100% UIS Tested, 100% △Vds Tested
- Pb-Free Lead Plating
- RoHS compliant
- Halogen Free

V_{DSS}	200V
I_D @V_{GS}= 10V	96A
$R_{DS(ON)\_Typ.}$@V_{GS}=10V	9.3mΩ

TYPICAL APPLICATIONS：

- Power Management
- Load Switch
- PWM Application

TO-220AB

MAXIMUM RATINGS (at T_C = 25 °C, unless otherwise specified)

Characteristic	Condition	Symbol	Value	Unit
Drain-Source Voltage		V_{DS}	200	V
Gate-Source Voltage		V_{GS}	±20	V
Continuous Drain Current	Tc=25℃ Tc=100℃	I_D	96 60	A
Pulsed Drain Current (1)		I_{DM}	Refer to Fig4	A
Single Pulsed Avalanche Energy (2)		E_{AS}	1006	mJ
Power dissipation	Tc=25℃ Tc=100℃	P_D	253 101	W
Junction & Storage temperature Range		T_J, T_{STG}	-55~+150	℃

Notes： 1. Repetitive Rating : Pulse Width Limited by Maximum Junction Temperature.
2. E_{AS} condition: Starting T_J=25℃, V_{DD}=100V, V_G=10V, R_G=25ohm, L=3mH, I_{AS}=25.9A, V_{DD}=0V during time in avalanche.

THERMAL CHARACTERISTICS

Characteristic	Condition	Symbol	Value	Unit
Thermal resistance,	Junction to Ambient Junction to Case	$R_{\theta JA}$ $R_{\theta JC}$	63 0.5	℃/W

ELECTRICAL CHARATERISTICS (at T_J = 25 °C, unless otherwise specified)

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage VGS = 0V, ID = 250uA	$V_{(BR)DSS}$	200			V
Zero Gate Voltage Drain Current VDS = 160 V, VGS = 0 V	I_{DSS}			1	uA
Gate-Source Leakage Current VGS = ±20V, VDS = 0V	I_{GSS}			±100	nA
Gate-Source threshold voltage VDS = VGS, ID = 250uA	$V_{GS(th)}$	2.2	3.1	4.0	V
Drain-Source On-State Resistance VGS = 10V, ID = 20A	$R_{DS(on)}$		9.3	11.7	mΩ
Input capacitance f=1MHz, VDS=100 V, VGS=0 V	C_{iss}		4089	5520	pF
Output capacitance f=1MHz, VDS=100 V, VGS=0 V	C_{oss}		429	580	pF
Reverse transfer capacitance f=1MHz, VDS=100 V, VGS=0 V	C_{rss}		11	14	pF
Gate Resistance f=1MHz	R_g		4.6		Ω
Total Gate Charge VDS= 100V, ID= 20A,VGS= 0 to 10V	Q_G		60	81	nC
Gate to Source Charge VDS= 100V, ID= 20A,VGS= 0 to 10V	Q_{GS}		22	29	nC
Gate to Drain Charge VDS= 100V, ID= 20A,VGS= 0 to 10V	Q_{GD}		15	20	nC
Turn-on delay time VDD=100 V, VGS= 10V, ID= 20A, R_{GEN}=2.7Ω	$td_{(ON)}$		14		ns
Rise time VDD=100 V, VGS= 10V, ID= 20A, R_{GEN}=2.7Ω	tr		37		ns
Turn-off delay time VDD=100 V, VGS= 10V, ID= 20A, R_{GEN}=2.7Ω	$td_{(OFF)}$		67		ns
Fall time VDD=100 V, VGS= 10V, ID= 20A, R_{GEN}=2.7Ω	tf		30		ns

Body Diode

ELECTRICAL CHARATERISTICS (at T_J = 25 °C, unless otherwise specified)

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Diode Forward Voltage VGS = 0V, I_S = 20A	V_{SD}			1.2	V
Maximum Continuous Body Diode Forward Current	I_S			96	A
Maximum Pulsed Body Diode Forward Current	I_{SM}			383	A
Revers Recovery Time IF=20A, di/dt = 100A/us	Trr		196	265	ns
Revers Recovery Charge IF=20A, di/dt = 100A/us	Qrr		702		nC

Typical Performance Characteristics

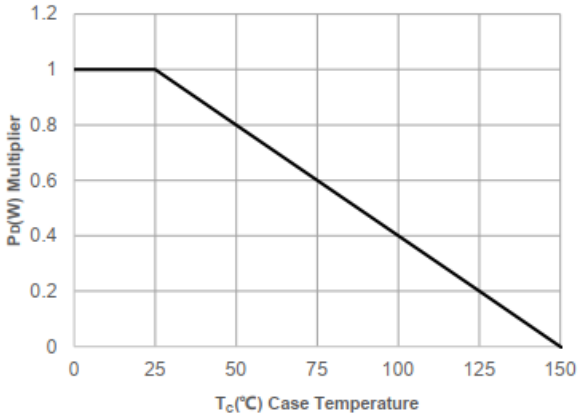


Figure 1. Power De-rating

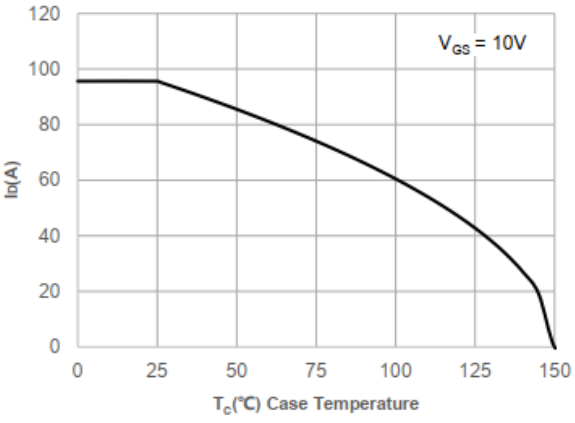


Figure 2. Current De-rating

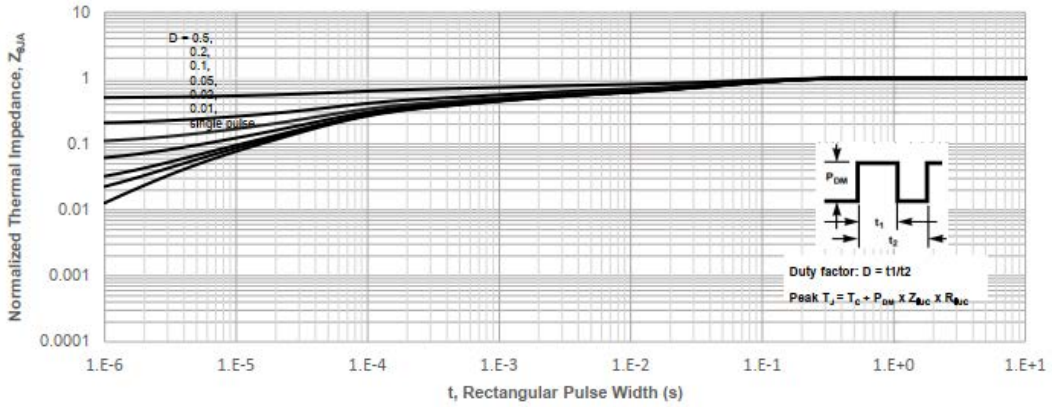


Figure 3. Normalized Maximum Transient Thermal Impedance

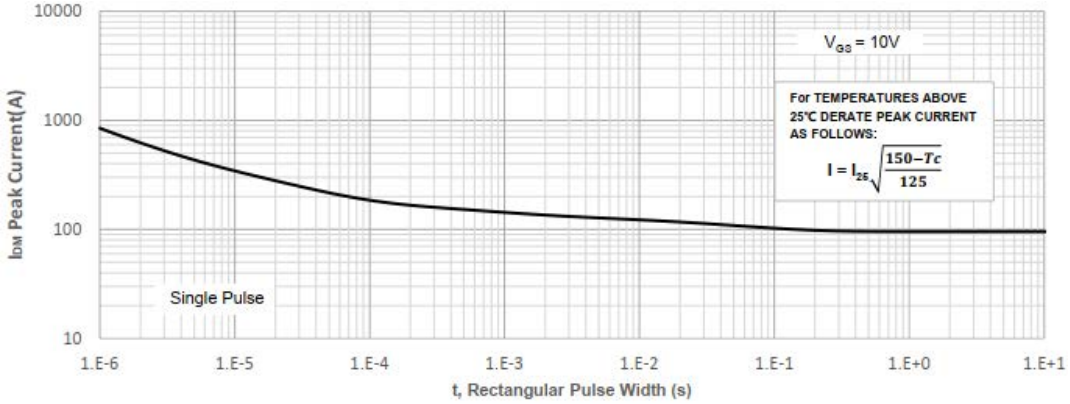


Figure 4. Peak Current Capacity

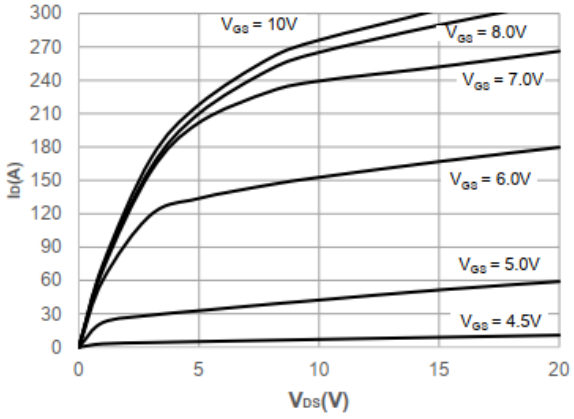


Figure 5. Output Characteristics

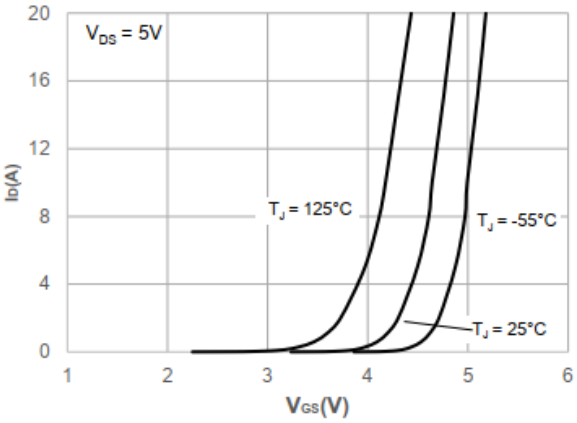


Figure 6. Typical Transfer Characteristics

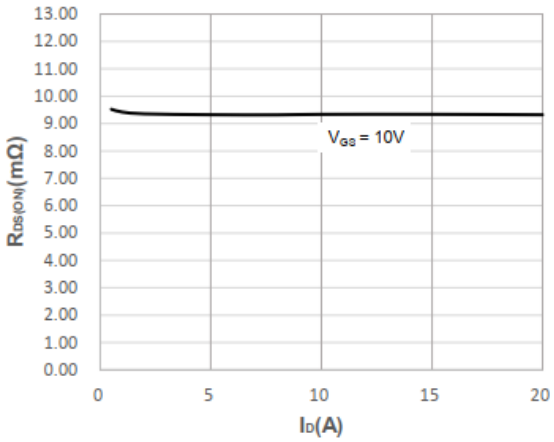


Figure 7. On-resistance vs. Drain Current

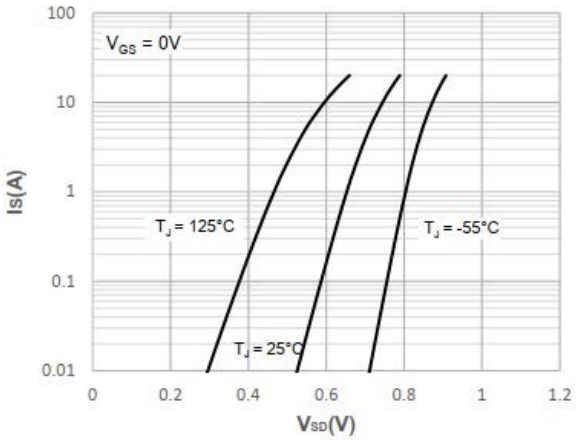


Figure 8. Body Diode Characteristics

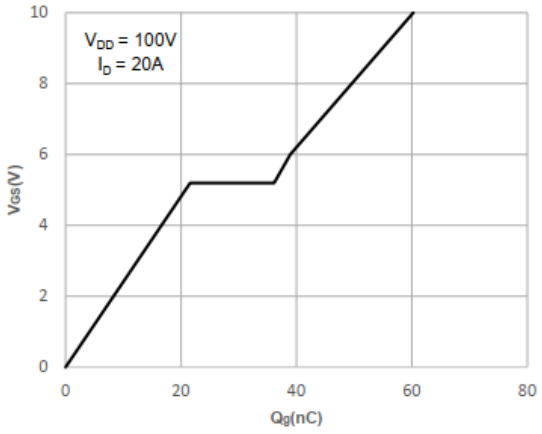


Figure 9. Gate Charge Characteristics

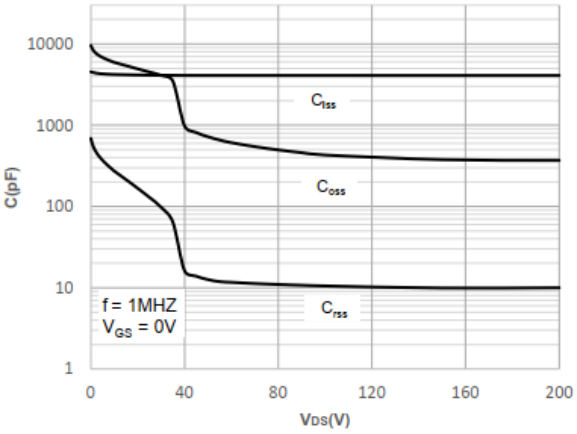


Figure 10. Capacitance Characteristics

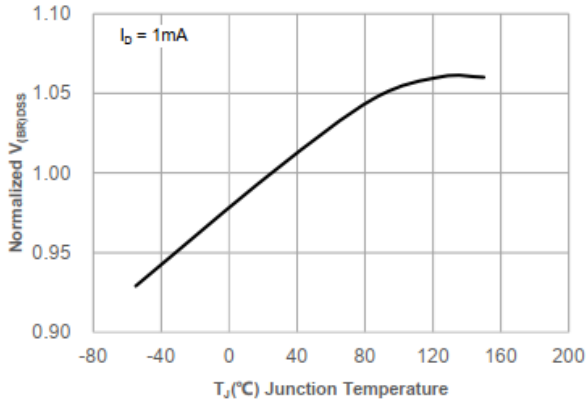


Figure 11. Normalized Breakdown voltage vs. Junction Temperature

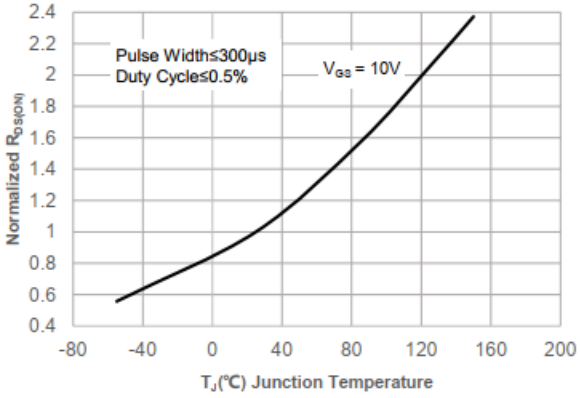


Figure 12. Normalized on Resistance vs. Junction Temperature

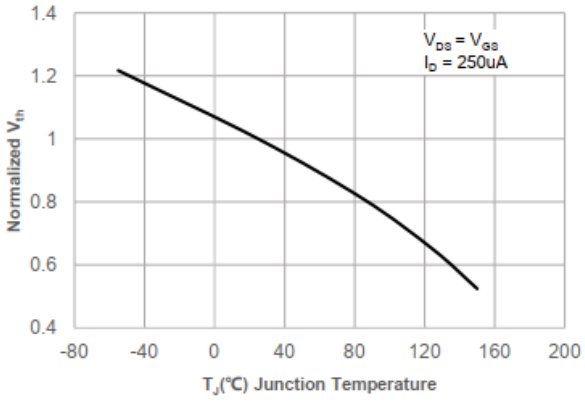


Figure 13. Normalized Threshold Voltage vs. Junction Temperature

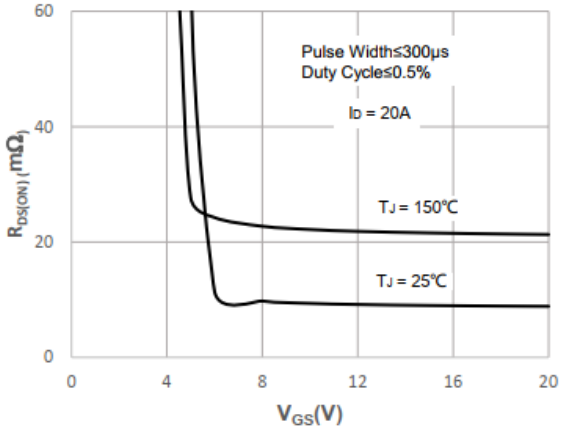


Figure 14. RDS(ON) vs. VGS

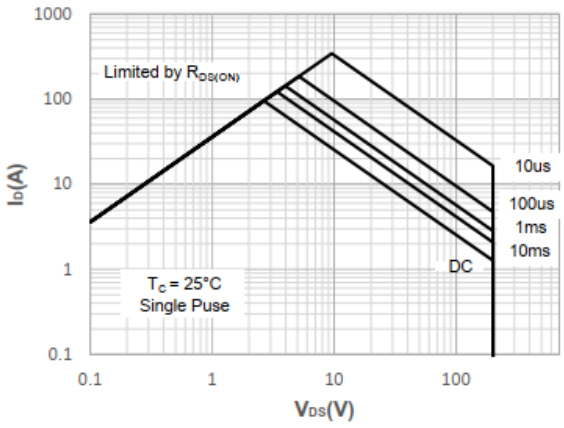
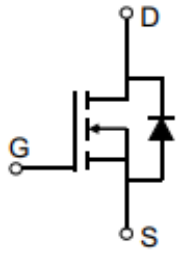
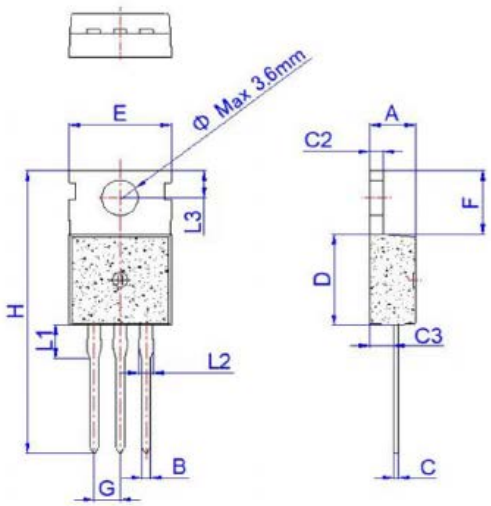


Figure 15. Maximum Safe Operating Area

• Circuit diagram



• Package outlines : Dimensions in (mm)



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.40		4.60	0.173		0.181
B	0.70		0.90	0.028		0.035
C	0.45		0.60	0.018		0.024
C2	1.23		1.32	0.048		0.052
C3	2.20		2.60	0.087		0.102
D	8.90		9.90	0.350		0.390
E	9.90		10.3	0.390		0.406
F	6.30		6.90	0.248		0.272
G		2.54			0.1	
H	28.0		29.8	1.102		1.173
L1		3.39			0.133	
L2	1.14		1.70	0.045		0.067
L3	2.65		2.95	0.104		0.116
Φ		3.6			0.142	

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